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(12) **United States Design Patent**  
**Wilson et al.**

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(54) **HEAT EXCHANGER INTERFACE SYSTEM**

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(71) Applicant: **The University of Kansas**, Lawrence, KS (US)

(72) Inventors: **George S. Wilson**, Lawrence, KS (US);  
**William Scott Jeffress**, Baldwin City, KS (US); **Frank J. Schoenen**, Lawrence, KS (US)

(73) Assignee: **The University of Kansas**, Lawrence, KS (US)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/579,468**

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**Related U.S. Application Data**

(63) Continuation-in-part of application No. 29/473,168, filed on Nov. 19, 2013, which is a continuation-in-part of application No. 13/966,496, filed on Aug. 14, 2013, now Pat. No. 9,463,495.

(51) **LOC (11) Cl.** ..... **23-03**

(52) **U.S. Cl.**  
USPC ..... **D23/323**

(58) **Field of Classification Search**  
USPC ..... D23/314, 323, 330, 386, 499; 165/181, 165/121, 166, 167, 170, 150, 151, 182, 165/172, 140, 41; 454/57, 49  
CPC ..... B01L 1/50; B01L 2300/185; F28D 15/00; B08B 15/023  
See application file for complete search history.

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*Primary Examiner* — T. Chase Nelson

*Assistant Examiner* — Ania Aman

(74) *Attorney, Agent, or Firm* — Valauskas Corder LLC

(57) **CLAIM**

The ornamental design for a heat exchanger interface system, as shown and described.

**DESCRIPTION**

FIG. 1 is a front view of a first embodiment of a heat exchanger interface system according to the present invention;

FIG. 2 is a rear view of the first embodiment of a heat exchanger interface system according to the present invention;

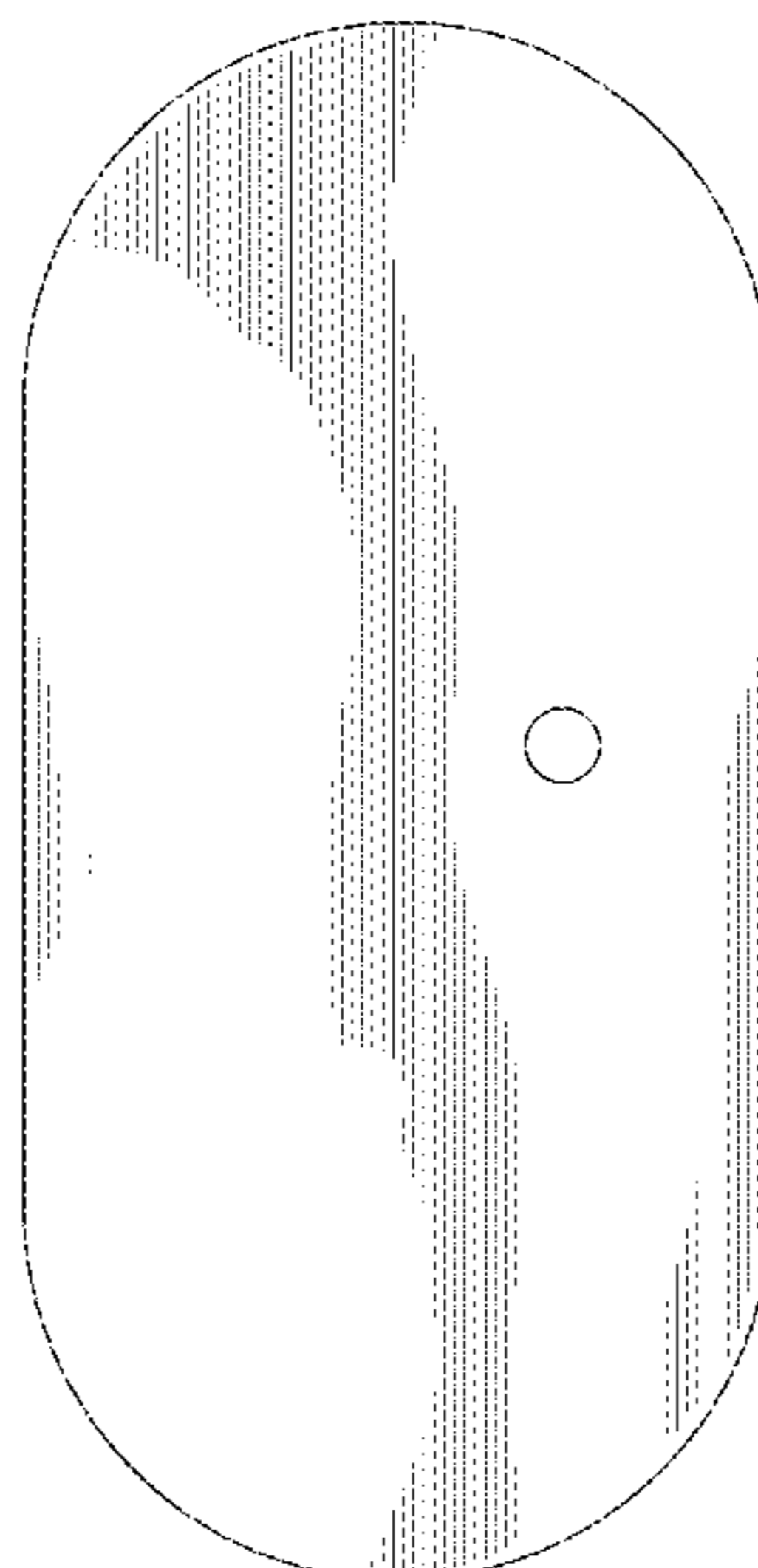
FIG. 3 is a side view of the first embodiment of a heat exchanger interface system according to the present invention;

FIG. 4 is a front view of a second embodiment of a heat exchanger interface system according to the present invention;

FIG. 5 is a rear view of the second embodiment of a heat exchanger interface system according to the present invention; and,

FIG. 6 is a side view of the second embodiment of a heat exchanger interface system according to the present invention.

**1 Claim, 6 Drawing Sheets**



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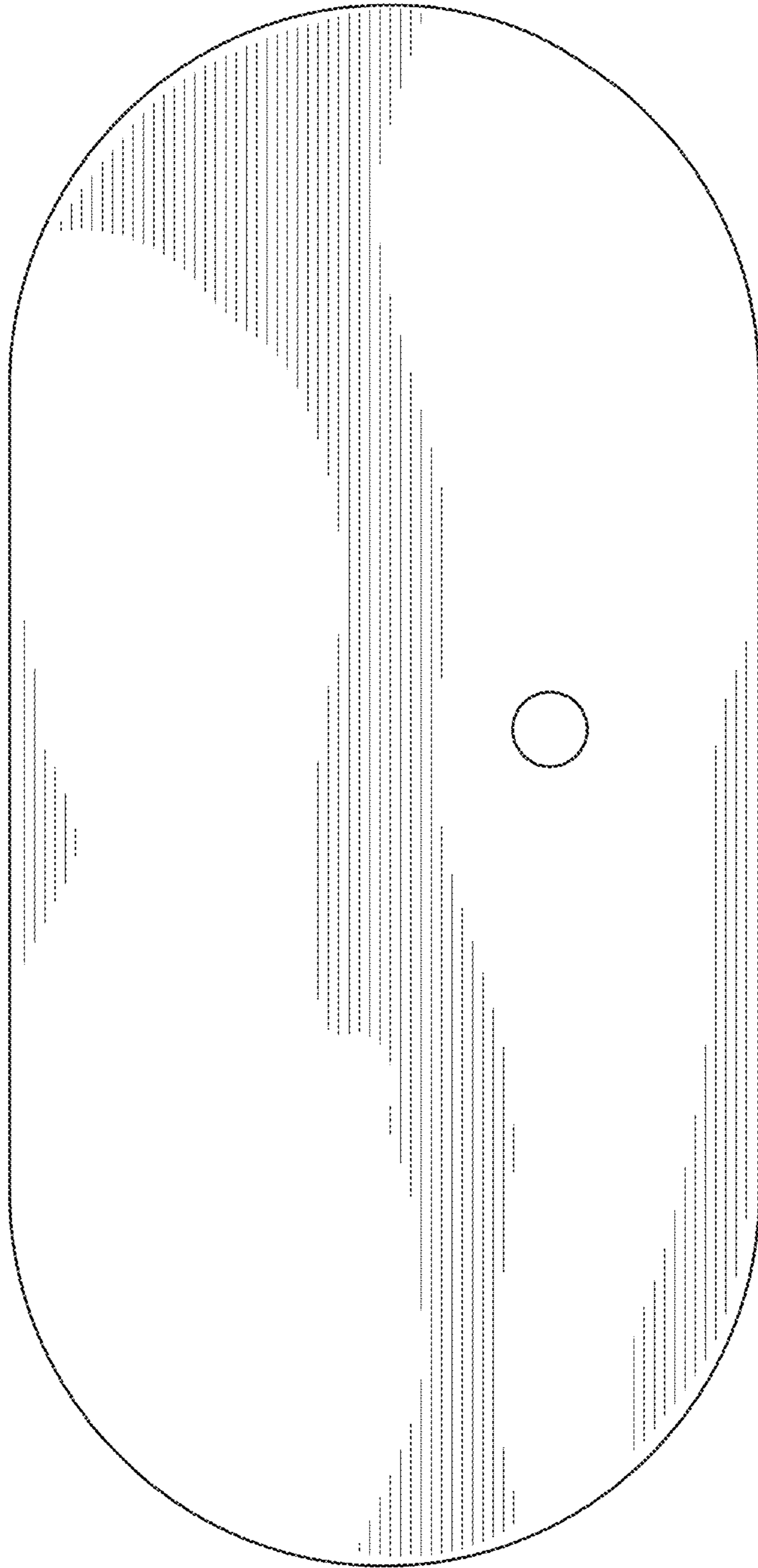


FIG. 1

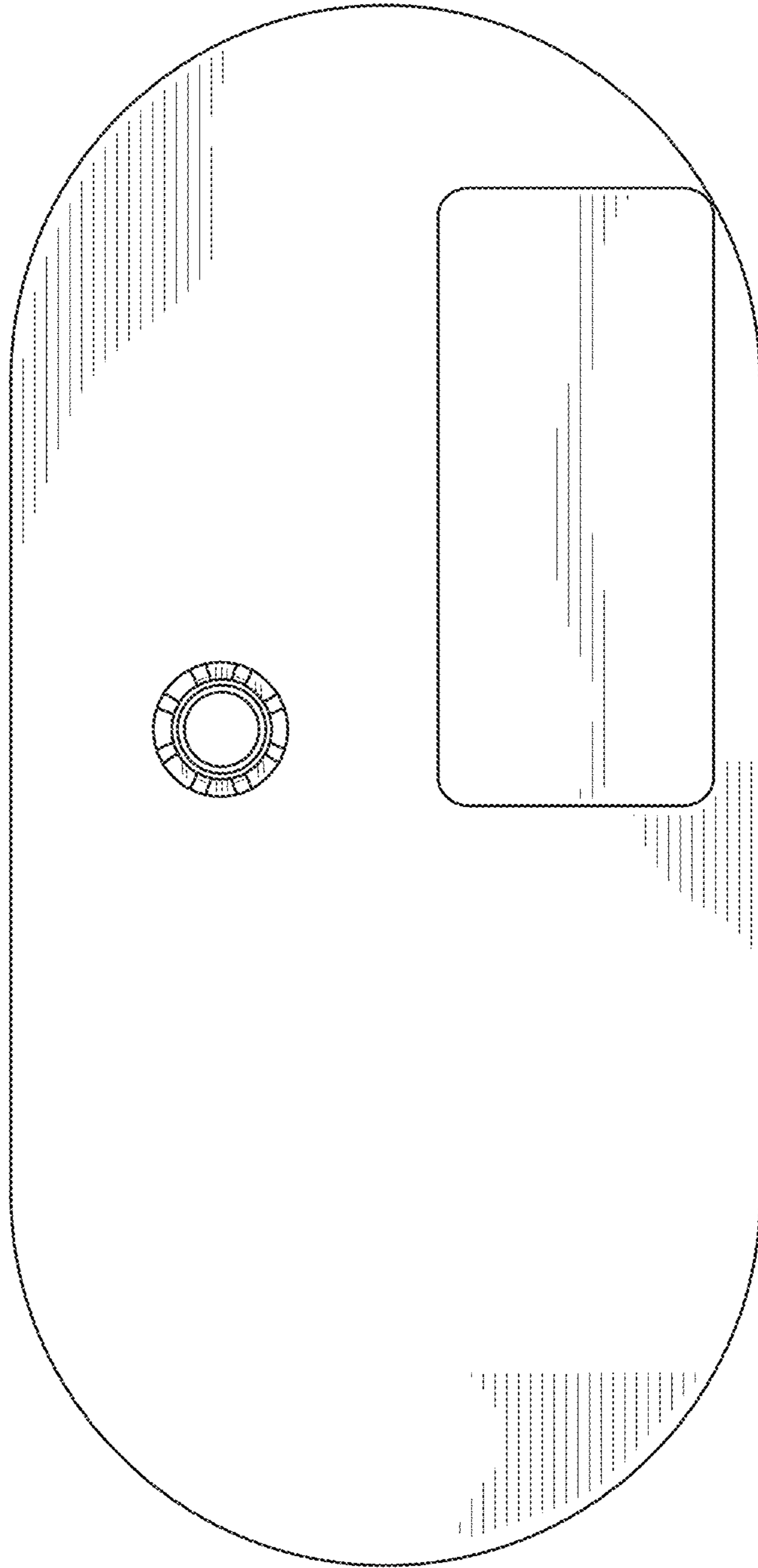


FIG. 2

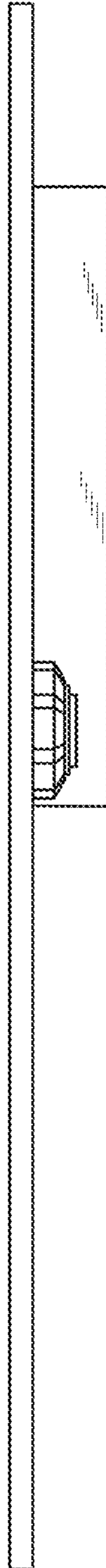


FIG. 3

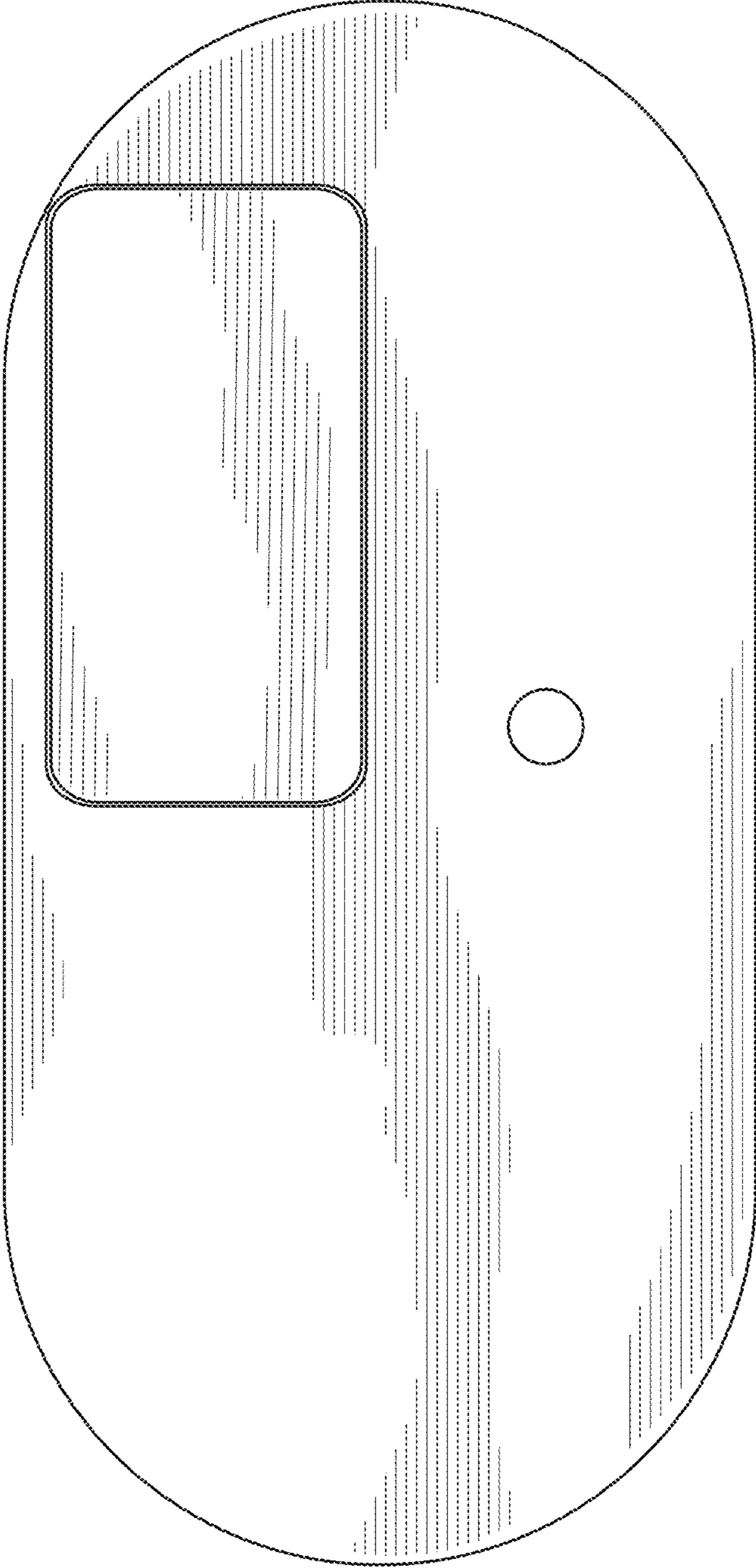


FIG. 4

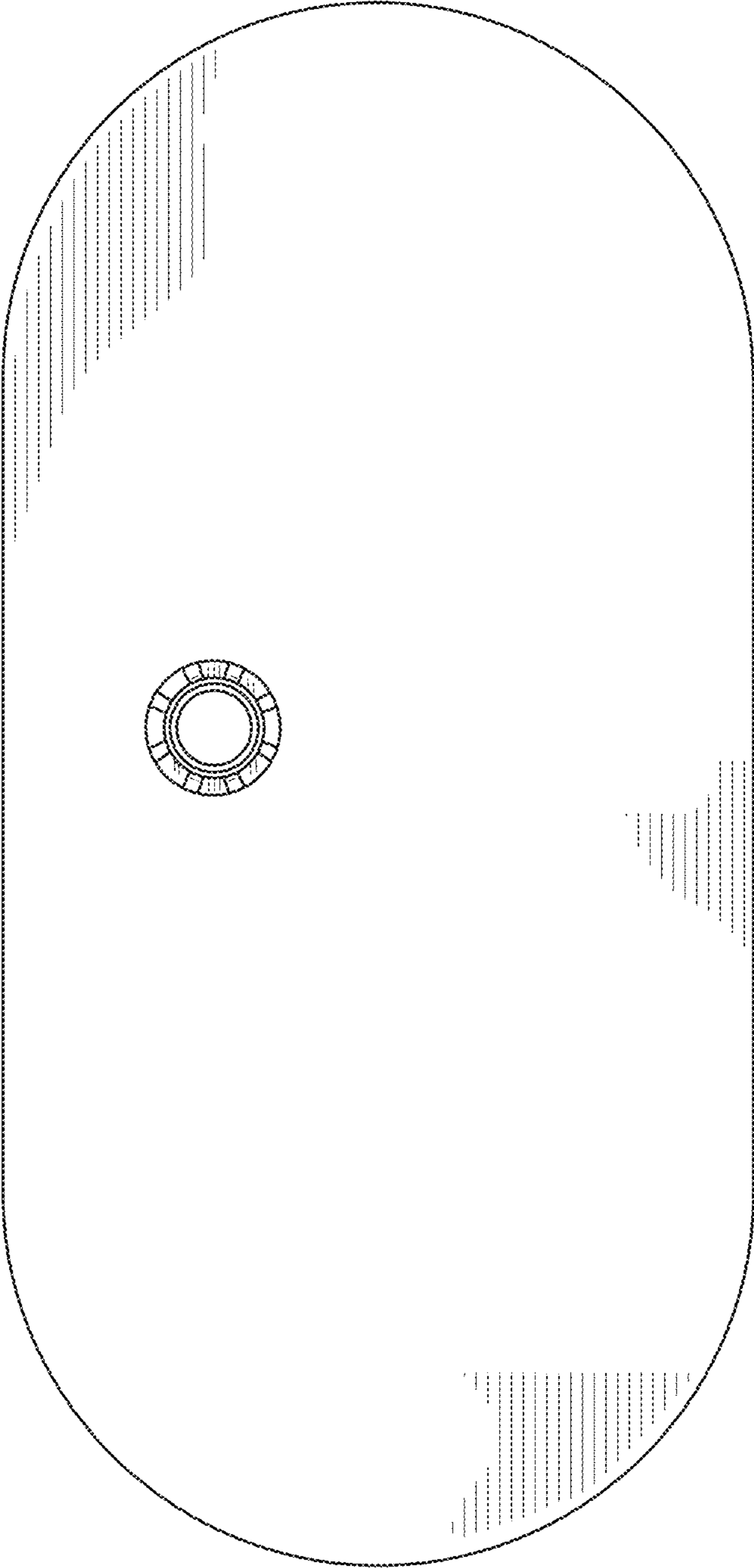


FIG. 5

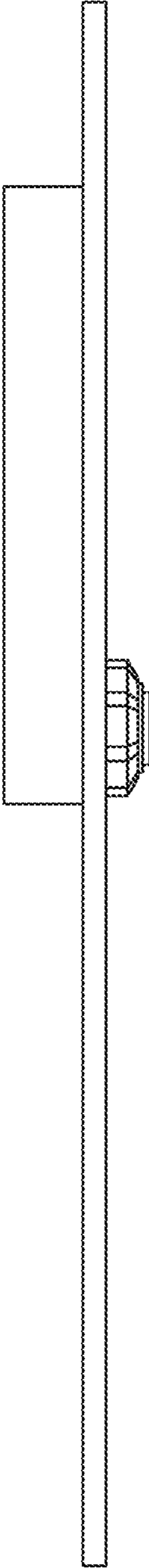


FIG. 6